National Semiconductor

PRELIMINARY

T-46-13-29
T-46-13-25

NMC27C010 (Former NMC27C1023)*
1,048,576-Bit (128k x 8) UV Erasable CMOS PROM

General Description

The NMC27C010 is a high-speed 1024k UV erasable and electrically reprogrammable CMOS EPROM, ideally suited for applications where fast turnaround, pattern experimentation and low power consumption are important requirements.

The NMC27C010 is designed to operate with a single +5V power supply with ±5% or ±10% tolerance. The CMOS design allows the part to operate over extended and military temperature ranges.

The NMC27C010 is packaged in a 32-pin dual-in-line package with transparent lid. The transparent lid allows the user to expose the chip to ultraviolet light to erase the bit pattern. A new pattern can then be written electrically into the device by following the programming procedure.

This EPROM is fabricated with National's proprietary, time proven CMOS double-poly silicon gate technology which combines high performance and high density with low power consumption and excellent reliability.

Features

- Clocked sense amps for fast access time down to 150 ns
- Low CMOS power consumption
  — Active power: 110 mW max
  — Standby power: 0.55 mW max
- Extended temperature range (NMC27C010QE), −40°C to +85°C and military temperature range (NMC27C010QM), −55°C to +125°C, available
- Pin compatible with NMOS bytewide 1024k EPROMs
- Fast and reliable programming—100 μs typical/byte
- Static operation—no clocks required
- TTL, CMOS compatible inputs/outputs
- TRI-STATE® output
- Optimum EPROM for total CMOS systems
- Manufacturer's identification code for automatic programming control
- High current CMOS level output drivers

Block Diagram
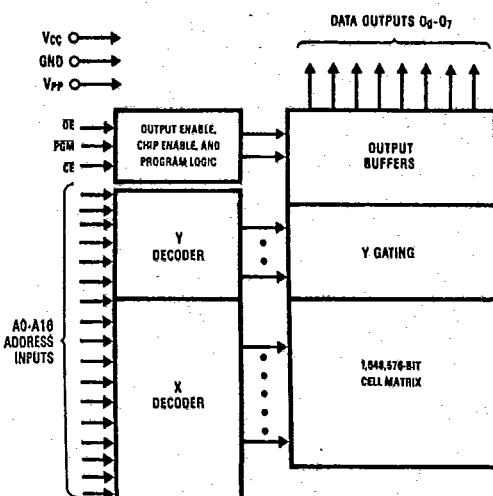
Pin Names	
A0–A16	Addresses
$\overline{CE}$	Chip Enable
$\overline{OE}$	Output Enable
O_0–O_7	Outputs
$\overline{PGM}$	Program
NC	No Connect

*Some programmer manufacturers will call this device NMC27C1023.

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Connection Diagram

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NMC27C010Q
Dual-In-Line Package

4 Mbit	2 Mbit
V_{PP}	V_{PP}
A16	A16
A15	A15
A12	A12
A7	A7
A6	A6
A5	A5
A4	A4
A3	A3
A2	A2
A1	A1
A0	A0
O_0	O_0
O_1	O_1
O_2	O_2
GND	GND

Pin (left)	#	#	Pin (right)
V_{PP}	1	32	V_{CC}
A16	2	31	$\overline{PGM}$
A15	3	30	NC
A12	4	29	A14
A7	5	28	A13
A6	6	27	A8
A5	7	26	A9
A4	8	25	A11
A3	9	24	$\overline{OE}$
A2	10	23	A10
A_1	11	22	$\overline{CE}$
A_0	12	21	O_7
O_0	13	20	O_6
O_1	14	19	O_5
O_2	15	18	O_4
GND	16	17	O_3
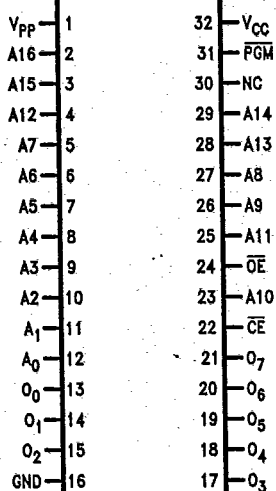
2 Mbit	4 Mbit
V_{CC}	V_{CC}
$\overline{PGM}$	A18
A17	A17
A14	A14
A13	A13
A8	A8
A9	A9
A11	A11
$\overline{OE}$	$\overline{OE}$
A10	A10
$\overline{CE}$	$\overline{CE}$
O_7	O_7
O_6	O_6
O_5	O_5
O_4	O_4
O_3	O_3

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Note: Socket compatible EPROM pin configurations are shown in the blocks adjacent to the NMC27C010 pins.

Order Number NMC27C010Q
See NS Package Number J32AQ

Commercial Temperature Range (0°C to +70°C)
V_{CC} = 5V ±5%

Parameter/Order Number	Access Time (ns)
NMC27C010Q15	150
NMC27C010Q17	170
NMC27C010Q20	200
NMC27C010Q25	250

Commercial Temperature Range (0°C to +70°C)
V_{CC} = 5V ±10%

Parameter/Order Number	Access Time (ns)
NMC27C010Q150	150
NMC27C010Q170	170
NMC27C010Q200	200
NMC27C010Q250	250

Extended Temperature Range (−40°C to +85°C)
V_{CC} = 5V ±10%

Parameter/Order Number	Access Time (ns)
NMC27C010QE170	170
NMC27C010QE200	200
NMC27C010QE250	250

Military Temperature Range (−55°C to +125°C)
V_{CC} = 5V ±10%

Parameter/Order Number	Access Time (ns)
NMC27C010QM170	170
NMC27C010QM200	200
NMC27C010QM250	250

NOTE: Surface mount PLCC package available for commercial and extended temperature ranges only.

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COMMERCIAL TEMPERATURE RANGE

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Absolute Maximum Ratings (Note 1)

Temperature Under Bias	$-10°C$ to $+80°C$	Power Dissipation	1.0W
Storage Temperature	$-65°C$ to $+150°C$	Lead Temperature (Soldering, 10 sec.)	300°C
All Input Voltages except A9 with Respect to Ground (Note 10)	$+6.5V$ to $-0.6V$	ESD Rating (Mil Spec 883C, Method 3015.2)	2000V
All Output Voltages with Respect to Ground (Note 10)	$V_{CC}+1.0V$ to $GND-0.6V$		

V_{PP} Supply Voltage and A9 with Respect to Ground During Programming $+14.0V$ to $-0.6V$

V_{CC} Supply Voltage with Respect to Ground $+7.0V$ to $-0.6V$

Operating Conditions (Note 7)

Temperature Range   0°C to $+70°C$

V_{CC} Power Supply
NMC27C010Q15, 17, 20, 25 $+5V \pm5\%$
NMC27C010Q150, 170, 200, 250 $+5V \pm10\%$

READ OPERATION

DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
I_{LI}	Input Load Current	$V_{IN} = V_{CC}$ or GND			1	µA
I_{LO}	Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, $\overline{CE} = V_{IH}$			1	µA
I_{CC1} (Note 9)	V_{CC} Current (Active) TTL Inputs	$\overline{CE} = V_{IL}$, f = 5 MHz Inputs = V_{IH} or V_{IL}, I/O = 0 mA		15	30	mA
I_{CC2} (Note 9)	V_{CC} Current (Active) CMOS Inputs	$\overline{CE} = $ GND, f = 5 MHz Inputs = V_{CC} or GND, I/O = 0 mA		10	20	mA
I_{CCSB1}	V_{CC} Current (Standby) TTL Inputs	$\overline{CE} = V_{IH}$		0.1	1	mA
I_{CCSB2}	V_{CC} Current (Standby) CMOS Inputs	$\overline{CE} = V_{CC}$		0.5	100	µA
I_{PP}	V_{PP} Load Current	$V_{PP} = V_{CC}$			10	µA
V_{IL}	Input Low Voltage		-0.2		0.8	V
V_{IH}	Input High Voltage		2.0		$V_{CC} + 1$	V
V_{OL1}	Output Low Voltage	$I_{OL} = 2.1$ mA			0.40	V
V_{OH1}	Output High Voltage	$I_{OH} = -2.5$ mA	3.5			V
V_{OL2}	Output Low Voltage	$I_{OL} = 10$ µA			0.1	V
V_{OH2}	Output High Voltage	$I_{OH} = -10$ µA	$V_{CC} - 0.1$			V

AC Electrical Characteristics

Symbol	Parameter	Conditions	NMC27C010								Units
			Q15, Q150		Q17, Q170		Q20, Q200		Q25, Q250		
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{ACC}	Address to Output Delay	$\overline{CE} = \overline{OE} = V_{IL}$ $\overline{PGM} = V_{IH}$		150		170		200		250	ns
t_{CE}	$\overline{CE}$ to Output Delay	$\overline{OE} = V_{IL}, \overline{PGM} = V_{IH}$		150		170		200		250	ns
t_{OE}	$\overline{OE}$ to Output Delay	$\overline{CE} = V_{IL}, \overline{PGM} = V_{IH}$		60		75		75		100	ns
t_{DF}	$\overline{OE}$ High to Output Float	$\overline{CE} = V_{IL}, \overline{PGM} = V_{IH}$	0	50	0	55	0	55	0	60	ns
t_{CF}	$\overline{CE}$ High to Output Float	$\overline{OE} = V_{IL}, \overline{PGM} = V_{IH}$	0	50	0	55	0	55	0	60	ns
t_{OH}	Output Hold from Addresses, $\overline{CE}$ or $\overline{OE}$, Whichever Occurred First	$\overline{CE} = \overline{OE} = V_{IL}$ $\overline{PGM} = V_{IH}$	0		0		0		0		ns

MILITARY AND EXTENDED TEMPERATURE RANGE

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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Temperature Under Bias	Operating Temp. Range
Storage Temperature	$-65°C$ to $+150°C$
All Input Voltages except A9 with Respect to Ground (Note 10)	$+6.5V$ to $-0.6V$
All Output Voltages with Respect to Ground (Note 10)	$V_{CC}+1.0V$ to $GND-0.6V$
V_{PP} Supply Voltage and A9 with Respect to Ground During Programming	$+14.0V$ to $-0.6V$

V_{CC} Supply Voltage with Respect to Ground	$+7.0V$ to $-0.6V$
Power Dissipation	1.0W
Lead Temperature (Soldering, 10 sec.)	300°C
ESD Rating (Mil Spec 883C, Method 3015.2)	2000V

Operating Conditions (Note 7)

Temperature Range	
NMC27C010QE150, 170, 200, 250	$-40°C$ to $+85°C$
NMC27C010QM170, 200, 250	$-55°C$ to $+125°C$
V_{CC} Power Supply	$+5V \pm 10\%$

READ OPERATION

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DC Electrical Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Units
I_{LI}	Input Load Current	$V_{IN} = V_{CC}$ or GND			10	μA
I_{LO}	Output Leakage Current	$V_{OUT} = V_{CC}$ or GND, $\overline{CE} = V_{IH}$			10	μA
I_{CC1} (Note 9)	V_{CC} Current (Active) TTL Inputs	$\overline{CE} = V_{IL}$, f = 5 MHz Inputs = V_{IH} or V_{IL}, I/O = 0 mA		15	30	mA
I_{CC2} (Note 9)	V_{CC} Current (Active) CMOS Inputs	$\overline{CE} = GND$, f = 5 MHz Inputs = V_{CC} or GND, I/O = 0 mA		10	20	mA
I_{CCSB1}	V_{CC} Current (Standby) TTL Inputs	$\overline{CE} = V_{IH}$		0.1	1	mA
I_{CCSB2}	V_{CC} Current (Standby) CMOS Inputs	$\overline{CE} = V_{CC}$		0.5	100	μA
I_{PP}	V_{PP} Load Current	$V_{PP} = V_{CC}$			10	μA
V_{IL}	Input Low Voltage		-0.2		0.8	V
V_{IH}	Input High Voltage		2.0		$V_{CC}+1$	V
V_{OL1}	Output Low Voltage	$I_{OL} = 2.1$ mA			0.40	V
V_{OH1}	Output High Voltage	$I_{OH} = -1.6$ mA	3.5			V
V_{OL2}	Output Low Voltage	$I_{OL} = 10 \mu A$			0.1	V
V_{OH2}	Output High Voltage	$I_{OH} = -10 \mu A$	$V_{CC} - 0.1$			V

AC Electrical Characteristics

Symbol	Parameter	Conditions	NMC27C010Q E150		E170, M170		E200, M200		E250, M250		Units
			Min	Max	Min	Max	Min	Max	Min	Max	
t_{ACC}	Address to Output Delay	$\overline{CE} = \overline{OE} = V_{IL}$ $\overline{PGM} = V_{IH}$		150		170		200		250	ns
t_{CE}	$\overline{CE}$ to Output Delay	$\overline{OE} = V_{IL}$, $\overline{PGM} = V_{IH}$		150		170		200		250	ns
t_{OE}	$\overline{OE}$ to Output Delay	$\overline{CE} = V_{IL}$, $\overline{PGM} = V_{IH}$		60		75		75		100	ns
t_{DF}	$\overline{OE}$ High to Output Float	$\overline{CE} = V_{IL}$, $\overline{PGM} = V_{IH}$	0	50	0	55	0	55	0	60	ns
t_{CF}	$\overline{CE}$ High to Output Float	$\overline{OE} = V_{IL}$, $\overline{PGM} = V_{IH}$	0	50	0	55	0	55	0	60	ns
t_{OH}	Output Hold from Addresses, $\overline{CE}$ or $\overline{OE}$, Whichever Occurred First	$\overline{CE} = \overline{OE} = V_{IL}$ $\overline{PGM} = V_{IH}$	0		0		0		0		ns

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Capacitance $T_A = +25°C, f = 1$ MHz (Note 2)

Symbol	Parameter	Conditions	Typ	Max	Units
C_{IN}	Input Capacitance	$V_{IN} = 0V$	9	15	pF
C_{OUT}	Output Capacitance	$V_{OUT} = 0V$	12	15	pF

AC Test Conditions

Output Load .... 1 TTL Gate and
$C_L = 100$ pF (Note 8)

Input Rise and Fall Times .... ≤5 ns
Input Pulse Levels .... 0.45V to 2.4V

Timing Measurement Reference Level
Inputs .... 0.8V and 2V
Outputs .... 0.8V and 2V

AC Waveforms (Notes 6, 7, & 9)
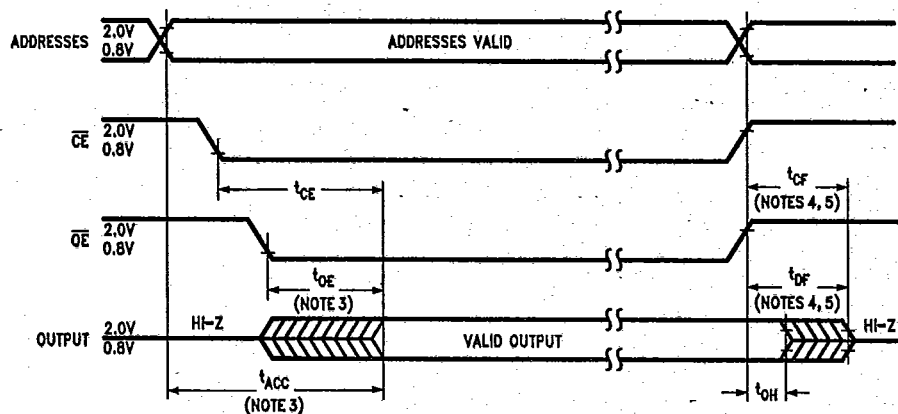
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Note 1: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note 2: This parameter is only sampled and is not 100% tested.

Note 3: $\overline{OE}$ may be delayed up to $t_{ACC} - t_{OE}$ after the falling edge of $\overline{CE}$ without impacting t_{ACC}.

Note 4: The t_{DF} and t_{CF} compare level is determined as follows:
High to TRI-STATE, the measured V_{OH1} (DC) − 0.10V;
Low to TRI-STATE, the measured V_{OL1} (DC) + 0.10V.

Note 5: TRI-STATE may be attained using $\overline{OE}$ or $\overline{CE}$.

Note 6: The power switching characteristics of EPROMs require careful device decoupling. It is recommended that at least a 0.1 μF ceramic capacitor be used on every device between V_{CC} and GND.

Note 7: The outputs must be restricted to $V_{CC} + 1.0V$ to avoid latch-up and device damage.

Note 8: 1 TTL Gate: $I_{OL} = 1.6$ mA, $I_{OH} = -400$ μA.
C_L: 100 pF includes fixture capacitance.

Note 9: V_{PP} may be connected to V_{CC} except during programming.

Note 10: Inputs and outputs can undershoot to −2.0V for 20 ns Max.

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Programming Characteristics (Notes 1, 2, 3 & 4)

| Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{AS}	Address Setup Time		1			μs
t_{OES}	$\overline{OE}$ Setup Time		1			μs
t_{CES}	$\overline{CE}$ Setup Time	$\overline{OE} = V_{IH}$	1			μs
t_{DS}	Data Setup Time		1			μs
t_{VPS}	V_{PP} Setup Time		1			μs
t_{VCS}	V_{CC} Setup Time		1			μs
t_{AH}	Address Hold Time		0			μs
t_{DH}	Data Hold Time		1			μs
t_{DF}	Output Enable to Output Float Delay	$\overline{CE} = V_{IL}$	0		60	ns
t_{PW}	Program Pulse Width		95	100	105	μs
t_{OE}	Data Valid from $\overline{OE}$	$\overline{CE} = V_{IL}$			100	ns
I_{PP}	V_{PP} Supply Current During Programming Pulse	$\overline{CE} = V_{IL}$ $\overline{PGM} = V_{IL}$			30	mA
I_{CC}	V_{CC} Supply Current				10	mA
T_A	Temperature Ambient		20	25	30	°C
V_{CC}	Power Supply Voltage		6.0	6.25	6.5	V
V_{PP}	Programming Supply Voltage		12.5	12.75	13.0	V
t_{FR}	Input Rise, Fall Time		5			ns
V_{IL}	Input Low Voltage			0.0	0.45	V
V_{IH}	Input High Voltage		2.4	4.0		V
t_{IN}	Input Timing Reference Voltage		0.8	1.5	2.0	V
t_{OUT}	Output Timing Reference Voltage		0.8	1.5	2.0	V

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Programming Waveforms (Note 3)

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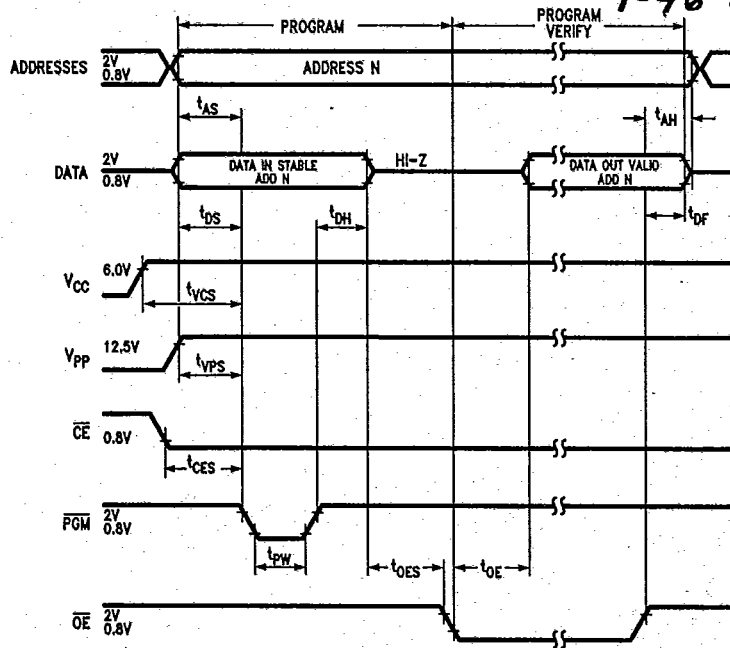
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Note 1: National's standard product warranty applies only to devices programmed to specifications described herein.

Note 2: V_{CC} must be applied simultaneously or before V_{PP} and removed simultaneously or after V_{PP}. The EPROM must not be inserted into or removed from a board with voltage applied to V_{PP} or V_{CC}.

Note 3: The maximum absolute allowable voltage which may be applied to the V_{PP} pin during programming is 14V. Care must be taken when switching the V_{PP} supply to prevent any overshoot from exceeding this 14V maximum specification. At least a 0.1 µF capacitor is required across V_{PP}, V_{CC} to GND to suppress spurious voltage transients which may damage the device.

Note 4: Programming and program verify are tested with the fast Program Algorithm, at typical power supply voltages and timings.
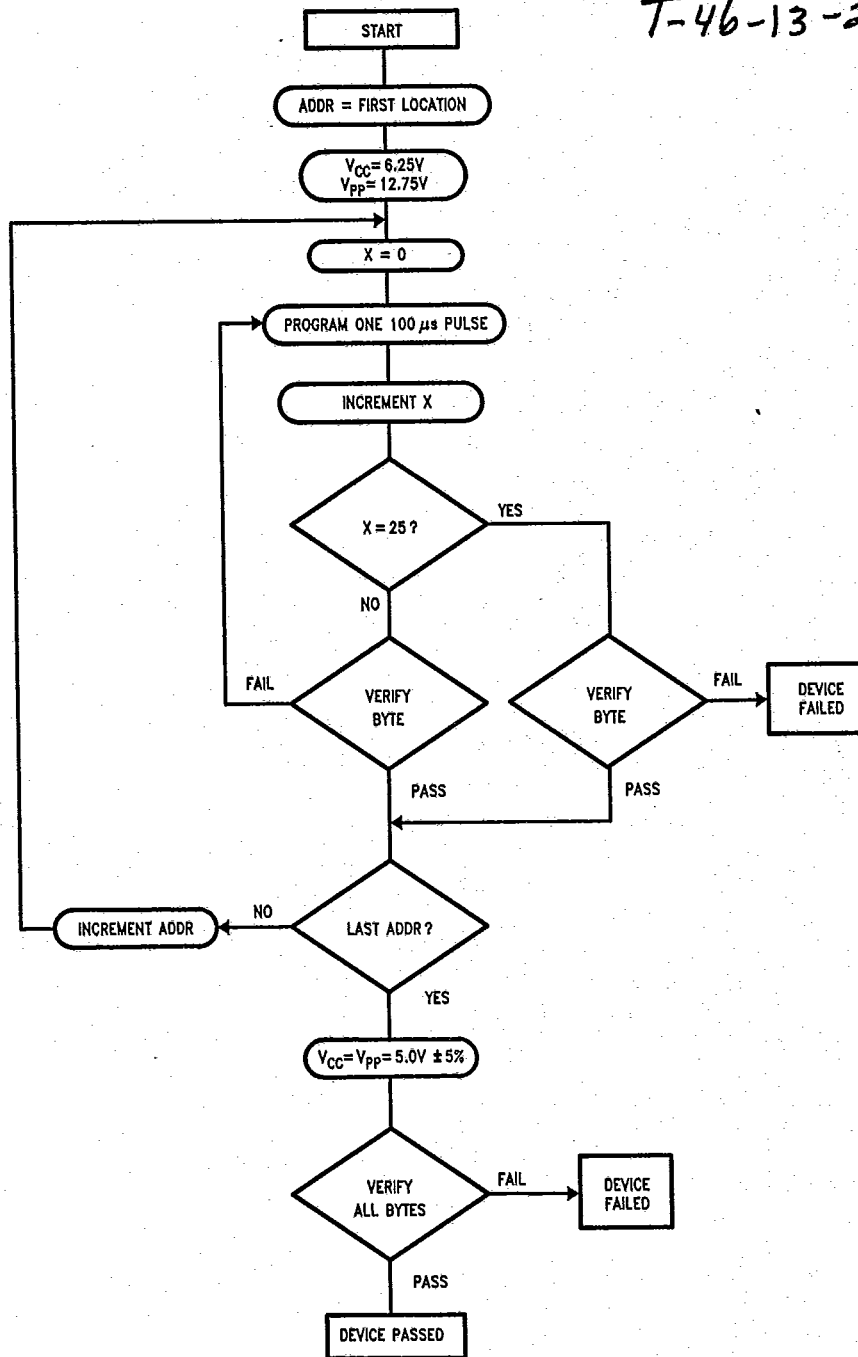
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Fast Programming Algorithm Flow Chart

```
                    START
                      │
             ADDR = FIRST LOCATION
                      │
              VCC= 6.25V
              VPP= 12.75V
                      │
                    X = 0
                      │
        ┌──► PROGRAM ONE 100 µs PULSE
        │             │
        │        INCREMENT X
        │             │
        │                      YES
        │         X = 25 ? ──────────┐
        │             │              │
        │            NO              │
        │                           │
   FAIL │         VERIFY        VERIFY      FAIL    DEVICE
        └─────────  BYTE         BYTE ──────────►   FAILED
                      │             │
                    PASS          PASS
                      │◄────────────┘
                      │
            NO                YES
  INCREMENT ADDR ◄─── LAST ADDR ?
        │                    │
        └────────────┐      YES
                     │       │
                     │  VCC=VPP=5.0V ±5%
                     │       │
                     │   VERIFY        FAIL    DEVICE
                     │  ALL BYTES ──────────►  FAILED
                     │       │
                     │     PASS
                     │       │
                     │  DEVICE PASSED
```

FIGURE 1

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Functional Description

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DEVICE OPERATION

The six modes of operation of the NMC27C010 are listed in Table I. It should be noted that all inputs for the six modes are at TTL levels. The power supplies required are V_{CC} and V_{PP}. The V_{PP} power supply must be at 12.75V during the three programming modes, and must be at 5V in the other three modes. The V_{CC} power supply must be at 6.25V during the three programming modes, and at 5V in the other three modes.

Read Mode

The NMC27C010 has two control functions, both of which must be logically active in order to obtain data at the outputs. Chip Enable ($\overline{CE}$) is the power control and should be used for device selection. Output Enable ($\overline{OE}$) is the output control and should be used to gate data to the output pins, independent of device selection. Assuming that addresses are stable, address access time (t_{ACC}) is equal to the delay from $\overline{CE}$ to output (t_{CE}). Data is available at the outputs t_{OE} after the falling edge of $\overline{OE}$, assuming that $\overline{CE}$ has been low and addresses have been stable for at least $t_{ACC}-t_{OE}$.

The sense amps are clocked for fast access time. V_{CC} should therefore be maintained at operating voltage during read and verify. If V_{CC} temporarily drops below the specified voltage (but not to ground) an address transition must be performed after the drop to insure proper output data.

Standby Mode

The NMC27C010 has a standby mode which reduces the active power dissipation by over 99%, from 110 mW to 0.55 mW. The NMC27C010 is placed in the standby mode by applying a CMOS high signal to the $\overline{CE}$ input. When in standby mode, the outputs are in a high impedance state, independent of the $\overline{OE}$ input.

Output OR-Tying

Because the NMC27C010 is usually used in larger memory arrays, National has provided a 2-line control function that accommodates this use of multiple memory connections. The 2-line control function allows for:

a) the lowest possible memory power dissipation, and

b) complete assurance that output bus contention will not occur.

To most efficiently use these two control lines, it is recommended that $\overline{CE}$ be decoded and used as the primary device selecting function, while $\overline{OE}$ be made a common connection to all devices in the array and connected to the READ line from the system control bus. This assures that all deselected memory devices are in their low power standby modes and that the output pins are active only when data is desired from a particular memory device.

Programming

CAUTION: Exceeding 14V on the V_{PP} or A9 pin will damage the NMC27C010.

Initially, and after each erasure, all bits of the NMC27C010 are in the "1" state. Data is introduced by selectively pro-

gramming "0's" into the desired bit locations. Although only "0's" will be programmed, both "1's" and "0's" can be presented in the data word. The only way to change a "0" to a "1" is by ultraviolet light erasure.

The NMC27C010 is in the programming mode when the V_{PP} power supply is at 12.75V and $\overline{OE}$ is at V_{IH}. It is required that at least a 0.1 μF capacitor be placed across V_{PP}, V_{CC} to ground to suppress spurious voltage transients which may damage the device. The data to be programmed is applied 8 bits in parallel to the data output pins. The levels required for the address and data inputs are TTL.

When the address and data are stable, an active low, TTL program pulse is applied to the $\overline{PGM}$ input. A program pulse must be applied at each address location to be programmed. The NMC27C010 is programmed with the Fast Programming Algorithm shown in *Figure 1*. Each Address is programmed with a series of 100 μs pulses until it verifies good, up to a maximum of 25 pulses. Most memory cells will program with a single 100 μs pulse. The NMC27C010 must not be programmed with a DC signal applied to the $\overline{PGM}$ input.

Programming multiple NMC27C010 in parallel with the same data can be easily accomplished due to the simplicity of the programming requirements. Like inputs of the parallel NMC27C010 may be connected together when they are programmed with the same data. A low level TTL pulse applied to the $\overline{PGM}$ input programs the paralleled NMC27C010.

Program Inhibit   T-46-13-25

Programming multiple NMC27C010's in parallel with different data is also easily accomplished. Except for $\overline{CE}$ all like inputs (including $\overline{OE}$ and $\overline{PGM}$) of the parallel NMC27C010 may be common. A TTL low level program pulse applied to an NMC27C010's $\overline{PGM}$ input with $\overline{CE}$ at V_{IL} and V_{PP} at 12.75V will program that NMC27C010. A TTL high level $\overline{CE}$ input inhibits the other NMC27C010's from being programmed.

Program Verify

A verify should be performed on the programmed bits to determine whether they were correctly programmed. The verify may be performed with V_{PP} at 12.75V. V_{PP} must be at V_{CC}, except during programming and program verify.

Manufacturer's Identification Code

The NMC27C010 has a manufacturer's identification code to aid in programming. When the device is inserted in an EPROM programmer socket, the programmer reads the code and then automatically calls up the specific programming algorithm for the part. This automatic programming control is only possible with programmers which have the capability of reading the code.

The Manufacturer's Identification code, shown in Table II, specifically identifies the manufacturer and the device type. The code for the NMC27C010 is "8F86", where "8F" designates that it is made by National Semiconductor, and "86" designates a 1Megabit byte-wide part.

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Functional Description (Continued)

TABLE I. Mode Selection

Pins / Mode	$\overline{CE}$ (22)	$\overline{OE}$ (24)	$\overline{PGM}$ (31)	V_{PP} (1)	V_{CC} (32)	Outputs (13–15, 17–21)
Read	V_{IL}	V_{IL}	V_{IH}	V_{CC}	5V	D_{OUT}
Standby	V_{IH}	Don't Care	Don't Care	V_{CC}	5V	HI-Z
Output Disable	Don't Care	V_{IH}	V_{IH}	V_{CC}	5V	HI-Z
Program	V_{IL}	V_{IH}	V_{IL}	12.75V	6.25V	D_{IN}
Program Verify	V_{IL}	V_{IL}	V_{IH}	12.75V	6.25V	D_{OUT}
Program Inhibit	V_{IH}	Don't Care	Don't Care	12.75V	6.25V	HI-Z

TABLE II. Manufacturer's Identification Code

Pins	A_0 (12)	O_7 (21)	O_6 (20)	O_5 (19)	O_4 (18)	O_3 (17)	O_2 (15)	O_1 (14)	O_0 (13)	Hex Data
Manufacturer Code	V_{IL}	1	0	0	0	1	1	1	1	8F
Device Code	V_{IH}	1	0	0	0	0	1	1	0	86

The code is accessed by applying 12V ±0.5V to address pin A9. Addresses A1–A8, A10–A16, and all control pins are held at V_{IL}. Address pin A0 is held at V_{IL} for the manufacturer's code, and held at V_{IH} for the device code. The code is read on the eight data pins, O_0–O_7. Proper code access is only guaranteed at 25°C ±5°C.

ERASURE CHARACTERISTICS

The erasure characteristics of the NMC27C010 are such that erasure begins to occur when exposed to light with wavelengths shorter than approximately 4000 Angstroms (Å). It should be noted that sunlight and certain types of fluorescent lamps have wavelengths in the 3000Å–4000Å range.

AFTER PROGRAMMING

Opaque labels should be placed over the NMC27C010 window to prevent unintentional erasure. Covering the window will also prevent temporary functional failure due to the generation of photo currents.

The recommended erasure procedure for the NMC27C010 is exposure to short wave ultraviolet light which has a wavelength of 2537 Angstroms (Å). The integrated dose (i.e., UV intensity × exposure time) for erasure should be a minimum of 15 W-sec/cm².

The NMC27C010 should be placed within 1 inch of the lamp tubes during erasure. Some lamps have a filter on their tubes which should be removed before erasure. Table III shows the minimum NMC27C010 erasure time for various light intensities.

An erasure system should be calibrated periodically. The distance from lamp to unit should be maintained at one inch. The erasure time increases as the square of the distance. (If distance is doubled the erasure time increases by a factor of 4.) Lamps lose intensity as they age. When a lamp is changed, the distance has changed, or the lamp has aged, the system should be checked to make certain full erasure is occurring. Incomplete erasure will cause symptoms that can be misleading. Programmers, components, and even system designs have been erroneously suspected when incomplete erasure was the problem.

SYSTEM CONSIDERATION

The power switching characteristics of EPROMs require careful decoupling of the devices. The supply current, I_{CC}, has three segments that are of interest to the system design)—the standby current level, the active current level, and the transient current peaks that are produced by voltage transitions on input pins. The magnitude of these transient current peaks is dependent on the output capacitance loading the device. The associated V_{CC} transient voltage peaks can be suppressed by properly selected decoupling capacitors. It is recommended that at least a 0.1 μF ceramic capacitor be used on every device between V_{CC} and GND. This should be a high frequency capacitor of low inherent inductance. In addition, at least a 4.7 μF bulk electrolytic capacitor should be used between V_{CC} and GND for each eight devices. The bulk capacitor should be located near where the power supply is connected to the array. The purpose of the bulk capacitor is to overcome the voltage drop caused by the inductive effects of the PC board traces.

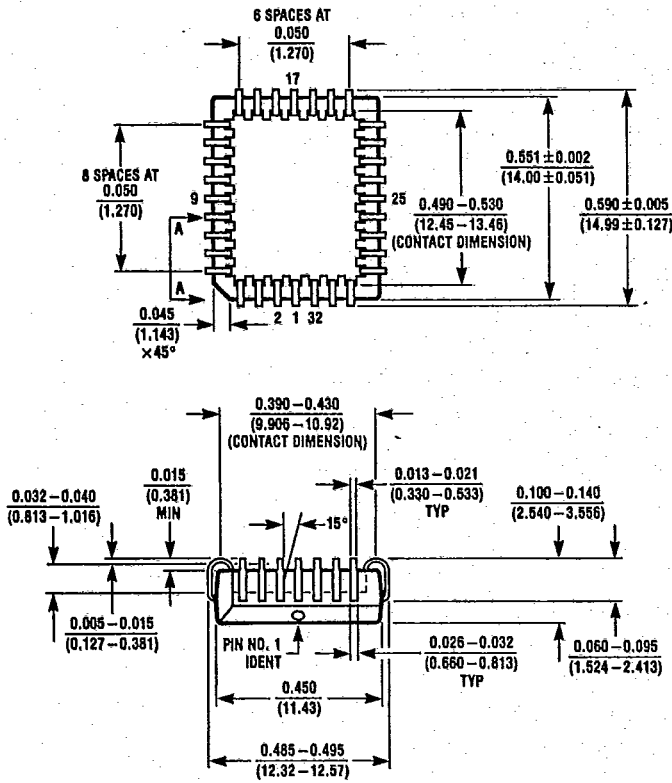### TABLE III. NMC27C010 Minimum Erasure Time

Light Intensity (μWatts/cm²)	Erasure Time (Minutes)
15,000	20
10,000	25
5,000	50

NMC27C010

T-46-13-29
T-46-13-25

Package Information

6 SPACES AT
0.050
(1.270)

17

8 SPACES AT
0.050
(1.270)

9

0.551 ± 0.002
(14.00 ± 0.051)

25   0.490 − 0.530
(12.45 − 13.46)
(CONTACT DIMENSION)

0.590 ± 0.005
(14.99 ± 0.127)

A
A

0.045
(1.143)
×45°

2 1 32

VIEW A-A

0.045
(1.143)
×45°

0.390 − 0.430
(9.906 − 10.92)
(CONTACT DIMENSION)

0.032 − 0.040
(0.813 − 1.016)

0.015
(0.381)
MIN

0.013 − 0.021
(0.330 − 0.533)
TYP

0.100 − 0.140
(2.540 − 3.556)

−15°

0.005 − 0.015
(0.127 − 0.381)

PIN NO. 1
IDENT

0.026 − 0.032
(0.660 − 0.813)
TYP

0.060 − 0.095
(1.524 − 2.413)

0.450
(11.43)

0.485 − 0.495
(12.32 − 12.57)

32-Lead PLCC Package
Order Number NMC27C010V

TL/D/9182–10